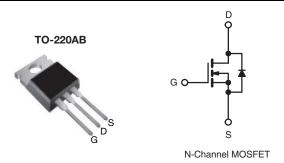
COMPLIANT

HALOGEN FREE



## **E Series Power MOSFET**

PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650	)
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V	0.125
Q <sub>g</sub> max. (nC)	130	)
Q <sub>gs</sub> (nC) 15		
Q <sub>gd</sub> (nC)	39	
Configuration	Sing	le



#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
  - LED lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
- · Battery chargers
- Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP30N60E-E3
Lead (Pb)-free and Halogen-free	SiHP30N60E-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_{\rm C}$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	600		
Gate-Source Voltage		$V_{GS}$	± 30	V		
Continuous Drain Current (T, = 150 °C)	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		29		
Continuous Drain Current (1) = 130 C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	18	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	65	ı	
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy b		E <sub>AS</sub>	690	mJ		
Maximum Power Dissipation			$P_{D}$	250	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	$V_{DS} = 0 \text{ V to } 80 \text{ % } V_{DS}$		dV/dt	70	V/ns	
Reverse Diode dV/dt <sup>d</sup>			uv/ui	18	V/IIS	
Soldering Recommendations (Peak Temperature) c	for	10 s		300	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 7 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu s$ , starting  $T_J = 25$  °C.



# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.5	G/ VV

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	2.8	4.0	V
Cata Cauraa Laglaga			V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	$I_{GSS}$		V <sub>GS</sub> = ± 30 V	-	-	± 1	μΑ
Zara Cata Valtaga Drain Current		V <sub>DS</sub> =	= 600 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 600 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	100	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 15 A	-	0.104	0.125	Ω
Forward Transconductance a	9 <sub>fs</sub>	V <sub>D</sub>	$_{S} = 8 \text{ V}, I_{D} = 3 \text{ A}$	-	5.4	-	S
Dynamic							
Input Capacitance	$C_{iss}$		$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		2600	-	pF
Output Capacitance	$C_{oss}$				138	-	
Reverse Transfer Capacitance	$C_{rss}$	f = 1.0 MHz		-	3	-	
Effective Output Capacitance, Energy Related <sup>b</sup>	$C_{o(er)}$	V 0V to 490 V V 0 V		-	98	-	
Effective Output Capacitance, Time Related <sup>c</sup>	$C_{o(tr)}$	VDS = 0 V	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		346	-	
Total Gate Charge	Qg			-	85	130	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 15 A, V_{DS} = 480 V$	-	15	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			=.	39	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	19	40	
Rise Time	t <sub>r</sub>	$V_{DD} = 380 \text{ V}, I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$		-	32	65	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	63	95	
Fall Time	t <sub>f</sub>				36	75	
Gate Input Resistance	$R_g$	f = 1	f = 1 MHz, open drain		0.63	-	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	Is	MOSFET sym showing the	MOSFET symbol showing the		-	29	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	65	- A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 15 A, V <sub>GS</sub> = 0 V		-	1.3	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 15 A, dl/dt = 100 A/μs, V <sub>R</sub> = 20 V		-	402	605	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>				7	15	μC
Reverse Recovery Current	I <sub>RRM</sub>				32	65	A

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . c.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

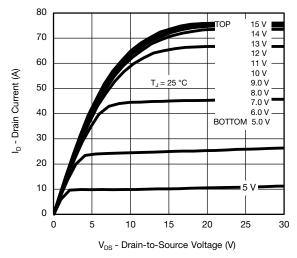


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

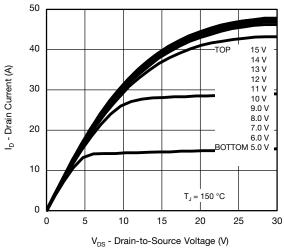


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

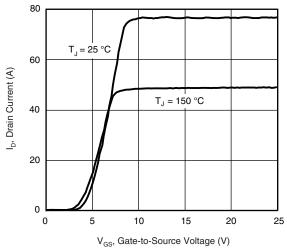


Fig. 3 - Typical Transfer Characteristics

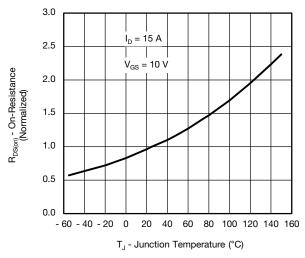


Fig. 4 - Normalized On-Resistance vs. Temperature

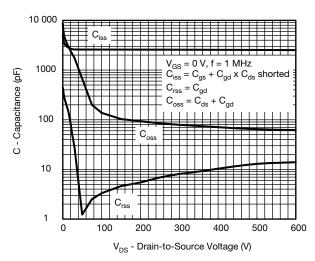


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

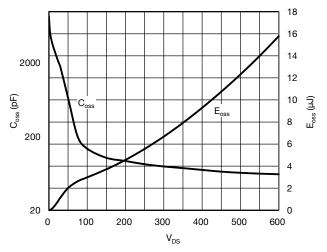


Fig. 6 - Coss and Eoss vs. VDS



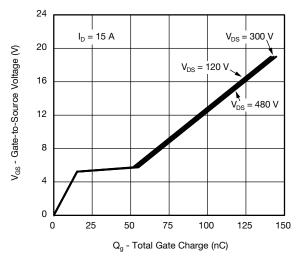


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

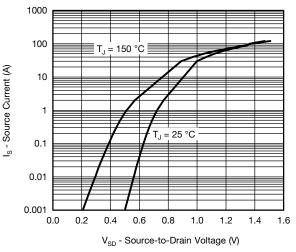


Fig. 8 - Typical Source-Drain Diode Forward Voltage

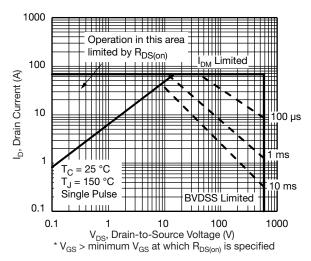


Fig. 9 - Maximum Safe Operating Area

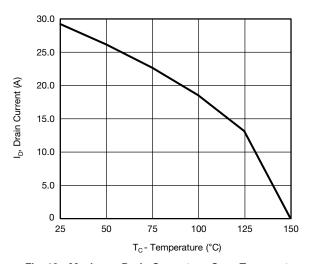


Fig. 10 - Maximum Drain Current vs. Case Temperature

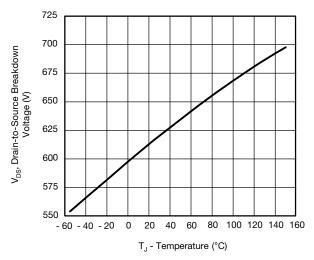
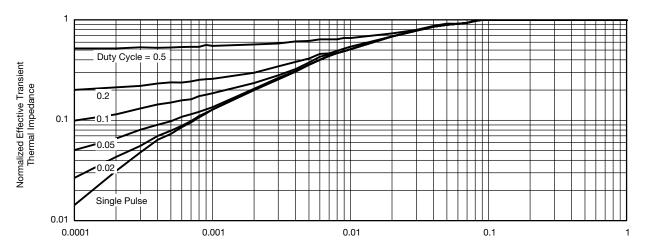


Fig. 11 - Temperature vs. Drain-to-Source Voltage





Square Wave Pulse Duration (s)
Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

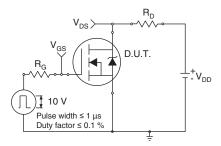


Fig. 13 - Switching Time Test Circuit

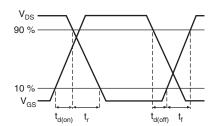


Fig. 14 - Switching Time Waveforms

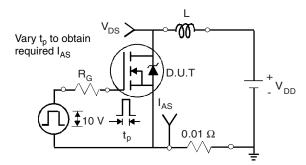


Fig. 15 - Unclamped Inductive Test Circuit

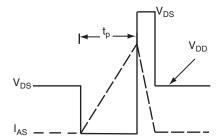


Fig. 16 - Unclamped Inductive Waveforms

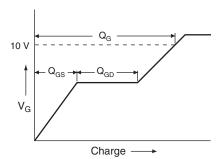


Fig. 17 - Basic Gate Charge Waveform

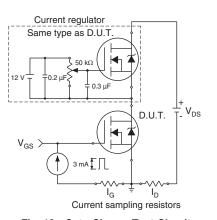
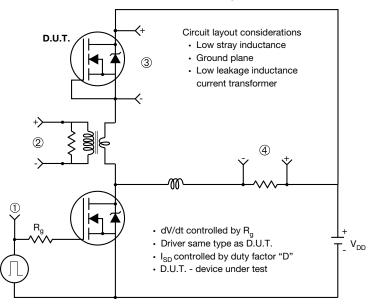


Fig. 18 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



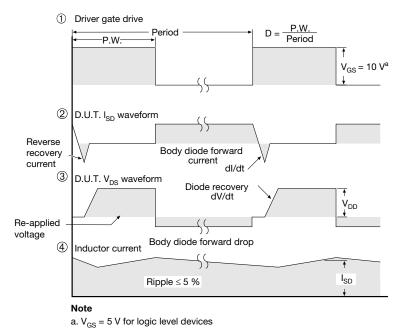
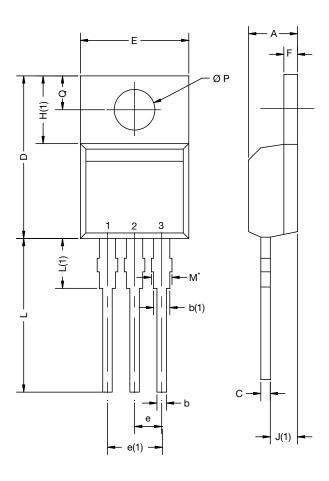


Fig. 19 - For N-Channel

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# TO-220-1



DIM.	MILLIM	METERS	INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

## Note

DWG: 6031

•  $M^* = 0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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